

BUL742

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- LARGE RBSOA

APPLICATIONS

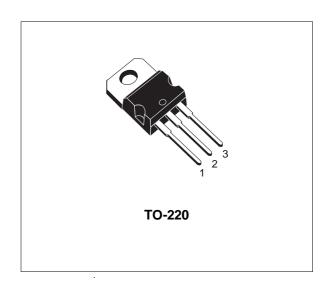
- ELECTRONIC BALLAST FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

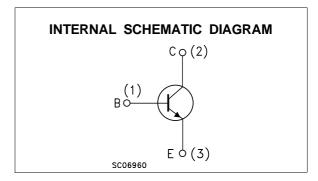


The BUL742 is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintening the wide RBSOA.

Thanks to an increased intermediate layer, it has an intrinsic ruggedness which enables the transistor to withstand an high collector current level during breakdown condition, without using the transil protection usually necessary in typical converters for lamp ballast.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage (V _{BE} = 0)	900	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V
V _{EBO}	Emitter-Base Voltage $(I_C = 0, I_B = 0.75 \text{ A}, t_p < 10\mu\text{s}, T_j < 150^{\circ}\text{C})$	BV _{EBO}	V
Ic	Collector Current	4	Α
I _{CM}	Collector Peak Current (t _p <5 ms)	8	Α
lΒ	Base Current	2	Α
I _{BM}	Base Peak Current (t _p <5 ms)	4	Α
P _{tot}	Total Dissipation at Tc = 25 °C	70	W
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

June 2001 1/5

THERMAL DATA

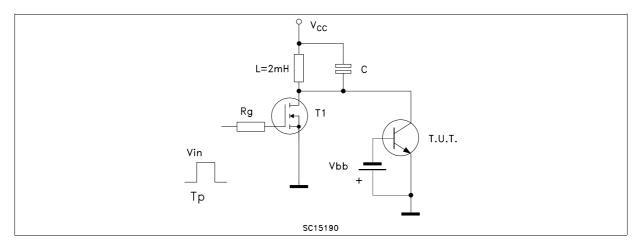
R _{thj-case}	Thermal Resistance Junction-Case	Max	1.78	°C/W
R _{thj-amb}	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 900 V				100	μΑ
$V_{\text{CEO(sus)}^{*}}$	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 100 mA	L = 25 mH	400			V
BV _{EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 1 mA		12			V
V _{CE(sat)*}	Collector-Emitter Saturation Voltage	I _C = 1 A I _C = 2 A I _C = 4 A	I _B = 0.2 A I _B = 0.4 A I _B = 0.8 A			0.5 1.0 1.5	V V V
$V_{BE(sat)^*}$	Base-Emitter Saturation Voltage	I _C = 2 A	$I_B = 0.4 A$			1.5	V
h _{FE} *	DC Current Gain	$I_C = 250 \text{ mA}$ $I_C = 2 \text{ A}$	$V_{CE} = 5 V$ $V_{CE} = 5 V$	35 10		70 35	
t _s t _f	RESISTIVE LOAD Storage Time Fall Time	$V_{CC} = 125 \text{ V}$ $I_{B1} = 45 \text{ mA}$ $t_p = 300 \mu\text{s}$	I _C = 0.5 A I _{B2} = -45 mA		11 250		μs ns
E _{sb}	Avalanche Energy	L = 2 mH		6			mJ

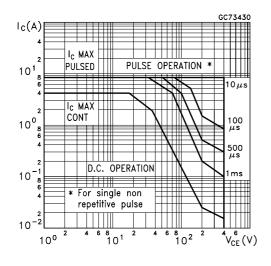
^{*} Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

Energy Rating Test Circuit

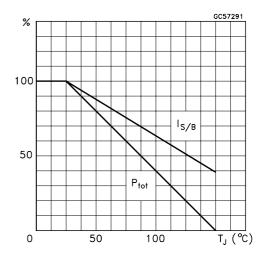


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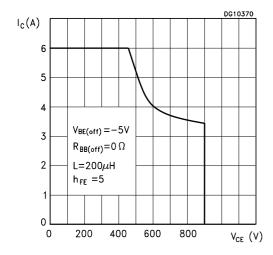
Safe Operating Areas



Derating Curve

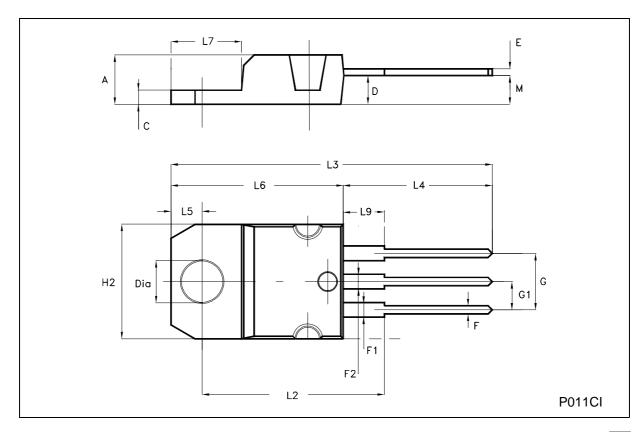


Reverse Biased SOA



TO-220 MECHANICAL DATA

DIM	mm			inch			
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α	4.40		4.60	0.173		0.181	
С	1.23		1.32	0.048		0.052	
D	2.40		2.72	0.094		0.107	
E	0.49		0.70	0.019		0.027	
F	0.61		0.88	0.024		0.034	
F1	1.14		1.70	0.044		0.067	
F2	1.14		1.70	0.044		0.067	
G	4.95		5.15	0.194		0.202	
G1	2.40		2.70	0.094		0.106	
H2	10.00		10.40	0.394		0.409	
L2		16.40			0.645		
L4	13.00		14.00	0.511		0.551	
L5	2.65		2.95	0.104		0.116	
L6	15.25		15.75	0.600		0.620	
L7	6.20		6.60	0.244		0.260	
L9	3.50		3.93	0.137		0.154	
М		2.60			0.102		
DIA.	3.75		3.85	0.147		0.151	



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